3.7mΩ, 40V, N-Channel Power MOSFET SRT04N037L

General Description

The Sanrise SRT04N037L is a low voltage power MOSFET, fabricated using advanced split gate trench technology. The resulting device has extremely low on resistance, low gate charge and fast switching time, making it especially suitable for applications which require superior power density.

The SRT04N037L break down voltage is 40V and it has a high rugged avalanche characteristics. The SRT04N037L is available in PDFN5*6 and PDFN3.3*3.3 packages.

Features

- Ultra Low

$R_{DS(ON)\_TYP}$ = 3.25mΩ,PDFN5*6@V_{GS} = 10V.

$R_{DS(ON)\_TYP}$ = 3.55mΩ,PDFN3.3*3.3@V_{GS} = 10V.

- Ultra Low Gate Charge, Qg=26nC typ.
- Fast switching capability
- Robust design with better EAS performance
- Non-automotive Qualified

Application

- Motor Driver
- E-Tools
- BMS
- Synchronous Rectifier

Symbol

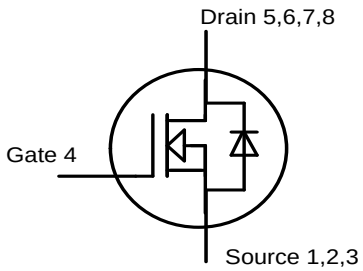
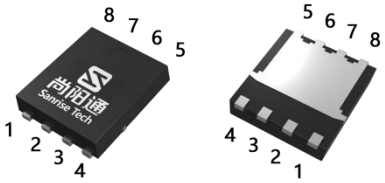
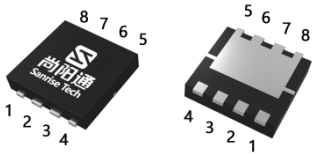


Figure 1 Symbol of SRT04N037L

Package Type



PDFN5*6



PDFN3.3*3.3

Figure 2 Package Type of SRT04N037L

Ordering Information

SRT04N037L□□–□

Circuit Type

Package

D56: PDFN5*6

D33: PDFN3.3*3.3

E: Lead Free

G: Green

Blank: Tube

TR: Tape & Reel

Package	Part Number	Marking ID	Packing Type
PDFN5*6	SRT04N037LD56TR-G	SRT04N037LD56G	Tape & Reel
PDFN3.3*3.3	SRT04N037LD33TR-G	04N037LD33G	Tape & Reel

3.7mΩ, 40V, N-Channel Power MOSFET SRT04N037L

Absolute Maximum Ratings

Parameter		Symbol	Rating		Unit
Drain-Source Voltage		V_{DSS}	40		V
Gate-Source Voltage		V_{GSS}	±20		V
Continuous Drain Current, Package Limited	T_C=25ºC	I_D	PDFN5*6	80	A
			PDFN3.3*3.3	60	
	T_C=125ºC		PDFN5*6	40	
			PDFN3.3*3.3	38	
Continuous Drain Current, Silicon	T_C=25ºC		PDFN5*6	90	
			PDFN3.3*3.3	86	
Pulsed Drain Current (Note 2)		I_{DM}	PDFN5*6	240	A
			PDFN3.3*3.3	180	
Power Dissipation (T_C = 25°C)		P_D	54		W
Avalanche Destructive Energy, Single Pulse (Note 4)		E_{AS_Limit}	225		mJ
Avalanche Energy, Single Pulse (Note 3)		E_{AS}	36		mJ
Avalanche Energy, Repetitive (Note 2)		E_{AR}	0.1		mJ
Avalanche Current, Repetitive (Note 2)		I_{AR}	20		A
Continuous Diode Forward Current		I_S	80		A
Diode Pulse Current		$I_{S.PULSE}$	240		A
Operating Junction Temperature		T_J	150		ºC
Storage Temperature		T_{STG}	-55 to 150		ºC
Lead Temperature (Soldering, 10 sec)		T_{LEAD}	260		ºC

Note:

1. Absolute maximum ratings are those values beyond which the device could be permanently damaged.Absolute maximum ratings are stress ratings only and functional device operation is not implied.
2. Repetitive Rating: Pulse width limited by maximum junction temperature
3. I_{AS}= 12A, V_{DD}= 20V, R_G= 25Ω, Starting T_J= 25°C
4. I_{AS_Limit}= 30A, V_{DD} = 20V, R_G = 25Ω, Starting T_J = 25°C

Thermal Resistance

Parameter		Symbol	Min	Typ	Max	Unit
Thermal Resistance，Junction-to-Case	PDFN5*6	R_{thJC}			2.3	ºC/W
	PDFN3.3*3.3	R_{thJC}			2.3	
Thermal Resistance，Junction-to-Ambient	PDFN5*6	R_{thJA}			50	
	PDFN3.3*3.3	R_{thJA}			60	

3.7mΩ, 40V, N-Channel Power MOSFET SRT04N037L

Electrical Characteristics

T_J = 25℃, unless otherwise specified.

Parameter		Symbol	Test Conditions	Min	Typ	Max	Unit
Statistic Characteristics							
Drain-Source Breakdown Voltage		BV_{DSS}	V_{GS}=0V, I_D=250uA	40			V
Zero Gate Voltage Drain Current		I_{DSS}	V_{DS}=40V, V_{GS}=0V			1	uA
Gate-Body Leakage Current	Forward	I_{GSSF}	V_{GS}=20V, V_{DS}=0V			200	nA
	Reverse	I_{GSSR}	V_{GS}=-20V, V_{DS}=0V			-200	
Gate Threshold Voltage		$V_{GS(TH)}$	V_{DS}=V_{GS}, I_D=0.25mA	1.2	1.8	2.4	V
Static Drain-Source On-Resistance		$R_{DS(ON)}$	V_{GS}=10V, I_D=20A (DFN5*6)		3.25	3.7	mΩ
			V_{GS}=10V,I_D=20A(DFN3.3*3.3)		3.55	4.1	
			V_{GS}=4.5V, I_D=5A (DFN5*6)		5.4	8.0	
			V_{GS}=4.5V, I_D=5A(DFN3.3*3.3)		5.7	8.5	
Gate Resistance		R_G	f=1MHz, Open Drain		3.0		Ω
Dynamic Characteristics							
Input Capacitance		C_{ISS}	V_{DS}=20V, V_{GS}=0V, f=1MHz		1.8		nF
Output Capacitance		C_{OSS}			487		pF
Reverse Transfer Capacitance		C_{RSS}			31		pF
Effective output capacitance, energy related NOTE5		$C_{O(er)}$	V_{GS}=0V, V_{DS}=0…20V		760		pF
Effective output capacitance, time related NOTE6		$C_{O(tr)}$			936		
Turn-on Delay Time		$t_{d(on)}$	V_{DD}=20V, I_D=20A R_G=1.6Ω, V_{GS}=10V		13		ns
Rise Time		t_r			35		
Turn-off Delay Time		$t_{d(off)}$			40		
Fall Time		t_f			8		
Gate Charge Characteristics							
Gate to Source Charge		Q_{gs}	V_{DD}=20V, I_D=20A V_{GS}=0 to 10V		3.9		nC
Gate to Drain Charge		Q_{gd}			3.0		
Gate Charge Total		Q_g			26		
Gate Plateau Voltage		$V_{plateau}$			2.4		V
Gate Charge Total, sync FET		Q_g	V_{DD}=0.1V, V_{GS}=0 to 10V		24.6		nC
Reverse Diode Characteristics							
Drain-Source Diode Forward Voltage		V_{SD}	V_{GS}=0V, I_{SD}=20A		0.82	1.0	V
Reverse Recovery Time		t_{rr}	V_R=20V, I_F=20A dI$_F$/dt=100A/us		46		ns
Reverse Recovery Charge		Q_{rr}			70		nC
Peak Reverse Recovery Current		I_{rrm}			3.1		A

Note:

5. $C_{O(er)}$ is a fixed capacitance that gives the same stored energy as C_{OSS} while V_{DS} is rising from 0 to 32V
6. $C_{O(tr)}$ is a fixed capacitance that gives the same charging time as C_{OSS} while V_{DS} is rising from 0 to 32 V

3.7mΩ, 40V, N-Channel Power MOSFET SRT04N037L

Sanrise Technology Limited Company

http://www.sanrise-tech.com

IMPORTANT NOTICE

Shenzhen Sanrise Technology Co., LTD. reserves the right to make changes without further notice to any products or specifications herein. Shenzhen Sanrise Technology Co., LTD. does not assume any responsibility for use of any its products for any particular purpose, nor does Shenzhen Sanrise Technology Co., LTD. assume any liability arising out of the application or use of any its products or circuits. Shenzhen Sanrise Technology Co., LTD. does not convey any license under its patent rights or other rights nor the rights of others.

Main Site:

- Headquarter

Shenzhen Sanrise Technology Co., LTD.

A1206, Skyworth building, No. 008, gaoxinnan 1st Road, Gaoxin District, Yuehai street,, Nanshan District, ShenZhen, P.R.China

Tel: +86-755-22953335

Fax: +86-755-22916878

- Shanghai Office

Sanrise Technology Limited Company

Rm.401, Building B, No. 666, Zhangheng Road, Zhangjiang Hi-Tech Park, Shanghai, P.R.China

Tel: +86-21-68825918